

Ceramic

Bandpass Filter

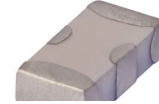
BFCN-3600+

50Ω

3300 to 3900 MHz

The Big Deal

- Flat group delay (± 33 pS)
- Narrow band/ fast roll-off in LTCC
- Good passband VSWR (1.2:1 typical)



CASE STYLE: FV1206

Product Overview

The BFCN-3600+ LTCC Bandpass Filter is constructed using multilayer ceramic technology to achieve miniature size and high repeatability of performance. Wrap-around terminations minimize variations in performance due to parasitics. Covering 3600 MHz $\pm$ 300 MHz, these units offer low insertion loss and good rejection at the band reject edges.

Key Features

Feature	Advantages
Flat group delay (± 33 pS)	The model has flat group delay which ensures low distortion.
Sharp shape factor	Sharp shape factor helps in adjacent channel rejection and hence increased selectivity.
Good VSWR, 1.2:1 typical over passband	This provides well matched input and output ports.
Wrap around termination	Provides excellent solderability and easy visual inspection capability.
LTCC construction	Provides a rugged package that is well suited for tough environments including high humidity and high temperature extremes
Small size, 0.12" x 0.6" x 0.4"	The surface mount package enables BFCN-3600+ to be used in compact designs.

Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

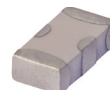


Bandpass Filter

50Ω

3300 to 3900 MHz

BFCN-3600+



Generic photo used for illustration purposes only

CASE STYLE: FV1206

Features

- Small size, 0.12" x 0.06"
- Temperature stable
- Hermetically sealed
- LTCC construction

Applications

- Harmonic rejection
- Transmitters / receivers

Electrical Specifications^{1,2} at 25°C

Parameter	F#	Frequency (MHz)	Min.	Typ.	Max.	Unit
Pass Band	Center Frequency	—	—	3600	—	MHz
	Insertion Loss	F1-F2	3300 - 3900	1.3	1.8	dB
	VSWR	F1-F2	3300 - 3900	1.3	1.5	:1
Stop Band, Lower	Insertion Loss	DC-F3	DC - 1850	20	24	dB
	VSWR	DC-F3	DC - 1850	—	52	:1
Stop Band, Upper	Insertion Loss	F4-F5	5000 - 8000	20	26	dB
	VSWR	F4-F5	5000 - 8000	—	16	:1

1. Measured on Mini-Circuits Characterization Test Board TB-270.

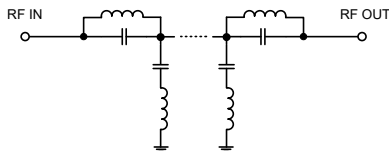
2. This filter is not intended for use as a DC Blocking circuit element. In Application where DC voltage is present at either input or output ports, blocking capacitors are required at the corresponding RF port.

Maximum Ratings

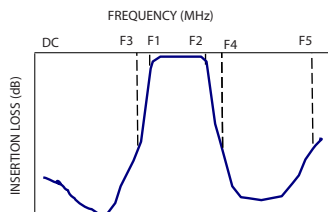
Operating Temperature	-55°C to 100°C
Storage Temperature	-55°C to 100°C
RF Power Input	1.5W max.

Permanent damage may occur if any of these limits are exceeded.

Functional Schematic



Typical Frequency Response



Typical Performance Data at 25°C

Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)	Frequency (MHz)	Group Delay (nsec)
10.00	96.80	17651.40	3300.00	0.65
60.00	80.80	4572.30	3310.00	0.64
100.00	75.05	7302.65	3330.00	0.64
320.00	67.83	742.78	3360.00	0.63
600.00	73.40	315.96	3390.00	0.63
1000.00	46.09	149.19	3420.00	0.62
1050.00	44.26	139.37	3450.00	0.62
1850.00	24.68	55.68	3480.00	0.62
3020.00	1.85	1.97	3510.00	0.62
3300.00	1.09	1.20	3570.00	0.62
3750.00	1.12	1.05	3600.00	0.62
4020.00	1.40	1.23	3630.00	0.63
4510.00	9.70	9.31	3660.00	0.63
4720.00	17.17	19.54	3690.00	0.64
5000.00	26.39	29.21	3720.00	0.64
6080.00	46.88	32.72	3750.00	0.65
7110.00	29.05	20.43	3780.00	0.65
8000.00	27.06	21.44	3810.00	0.65
9020.00	21.80	21.58	3870.00	0.67
10000.00	20.34	23.35	3900.00	0.68

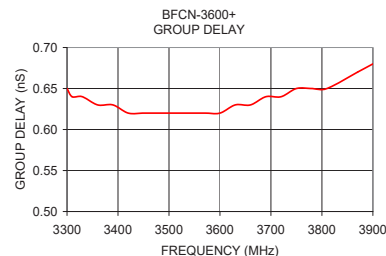
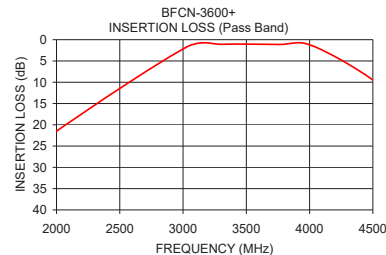
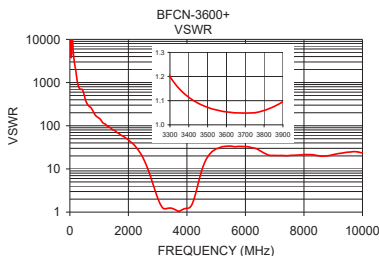
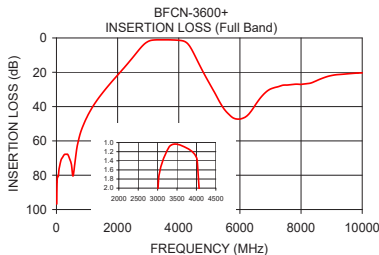
+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



Available Tape and Reel
at no extra cost

Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500, 1000, 3000



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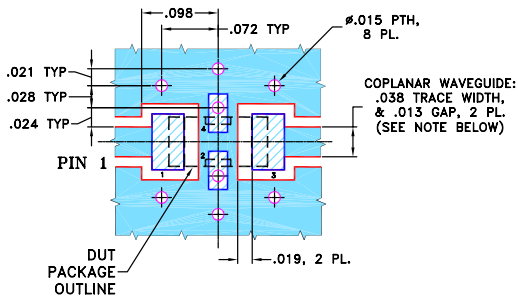
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REV. B
M151107
BFCN-3600+
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AD/CP/AM
190725
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Pin Connections

RF IN	1
RF OUT	3
GROUND	2,4

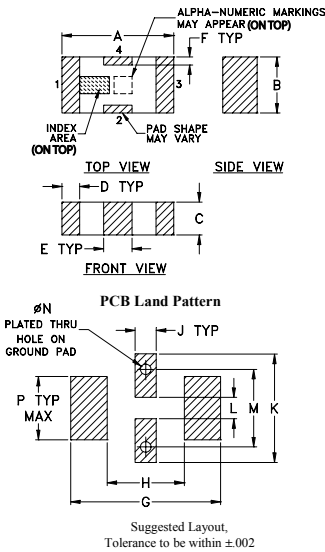
Demo Board MCL P/N: TB-270
Suggested PCB Layout (PL-137)



- NOTES: 1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR ROGERS R04350B WITH THICKNESS .020" ± .0015". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Product Marking: AY

Outline Drawing



Outline Dimensions (inch mm)

A	B	C	D	E	F	G	
.126	.063	.037	.020	.032	.009	.169	
3.20	1.60	0.94	0.51	0.81	0.23	4.29	
H	J	K	L	M	N	P	wt
.087	.024	.122	.024	.087	.012	.071	grams
2.21	0.61	3.10	0.61	2.21	0.30	1.80	.020

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Ceramic Bandpass Filter

BFCN-3600+

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)	FREQUENCY (MHz)	GROUP DELAY (ns)
10.0	96.80	0.00	1000.0	0.32
100.0	75.05	0.00	1130.0	0.27
200.0	69.56	0.01	1290.0	0.28
320.0	67.83	0.02	1450.0	0.32
430.0	70.44	0.03	1610.0	0.33
540.0	80.45	0.05	1770.0	0.32
600.0	73.40	0.05	1900.0	0.35
710.0	60.46	0.07	2080.0	0.36
830.0	53.00	0.09	2180.0	0.37
940.0	48.28	0.11	2270.0	0.38
1000.0	46.09	0.12	2360.0	0.41
1130.0	41.76	0.15	2460.0	0.45
1290.0	37.26	0.18	2550.0	0.49
1450.0	33.31	0.21	2640.0	0.56
1610.0	29.73	0.25	2740.0	0.62
1770.0	26.34	0.29	2830.0	0.70
1850.0	24.68	0.31	2920.0	0.75
1900.0	23.66	0.33	3020.0	0.76
2080.0	20.06	0.41	3110.0	0.73
2270.0	16.19	0.55	3200.0	0.69
2460.0	12.15	0.85	3300.0	0.65
2640.0	8.19	1.59	3310.0	0.64
2830.0	4.30	3.76	3330.0	0.64
3020.0	1.85	9.69	3360.0	0.63
3200.0	1.16	20.43	3390.0	0.63
3300.0	1.09	20.68	3420.0	0.62
3310.0	1.09	20.48	3450.0	0.62
3330.0	1.09	20.15	3480.0	0.62
3360.0	1.09	19.67	3510.0	0.62
3390.0	1.09	19.39	3540.0	0.63
3420.0	1.09	19.32	3570.0	0.62
3450.0	1.09	19.48	3600.0	0.62
3480.0	1.08	19.87	3630.0	0.63
3510.0	1.08	20.43	3660.0	0.63
3540.0	1.08	21.23	3690.0	0.64
3570.0	1.08	22.40	3720.0	0.64
3600.0	1.08	23.97	3750.0	0.65
3630.0	1.08	25.98	3780.0	0.65
3660.0	1.09	28.73	3810.0	0.65
3690.0	1.10	32.27	3840.0	0.67
3720.0	1.11	34.27	3870.0	0.67
3750.0	1.12	31.62	3900.0	0.68
3780.0	1.14	28.15	3950.0	0.70
3810.0	1.17	25.65	4020.0	0.75
3840.0	1.19	23.85	4090.0	0.80
3870.0	1.21	22.42	4160.0	0.87
3900.0	1.24	21.36	4230.0	0.95
3950.0	1.30	20.35	4300.0	0.97
4090.0	1.54	18.54	4370.0	0.92
4230.0	2.41	10.23	4440.0	0.82
4370.0	5.15	4.23	4510.0	0.70
4510.0	9.70	1.87	4580.0	0.61
4650.0	14.72	1.07	4650.0	0.54
4790.0	19.58	0.77	4720.0	0.48
4930.0	24.19	0.64	4790.0	0.43
5000.0	26.39	0.59	4860.0	0.42
5490.0	41.57	0.52	4930.0	0.39
6080.0	46.88	0.53	5000.0	0.41
6370.0	42.62	0.59	5190.0	0.42
6670.0	34.96	0.77	5490.0	0.65
6960.0	30.13	0.85	5780.0	0.41
7260.0	28.36	0.85	6370.0	0.01
7550.0	27.43	0.84	6960.0	0.58
7850.0	26.93	0.82	7550.0	0.29
8000.0	27.06	0.81	8000.0	0.27
8320.0	26.27	0.82	8600.0	0.30
8600.0	24.16	0.88	8880.0	0.33
9160.0	21.42	0.77	9440.0	0.31
10000.0	20.34	0.74	10000.0	0.33



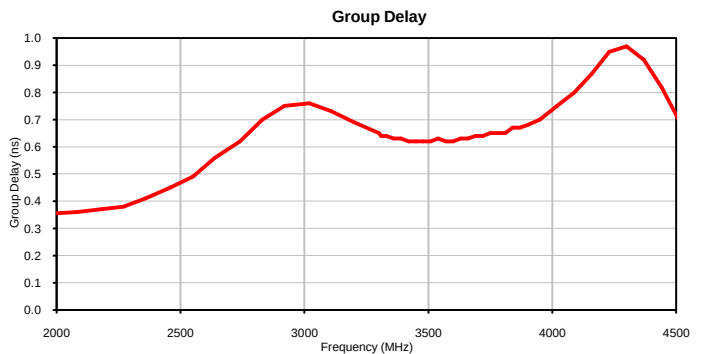
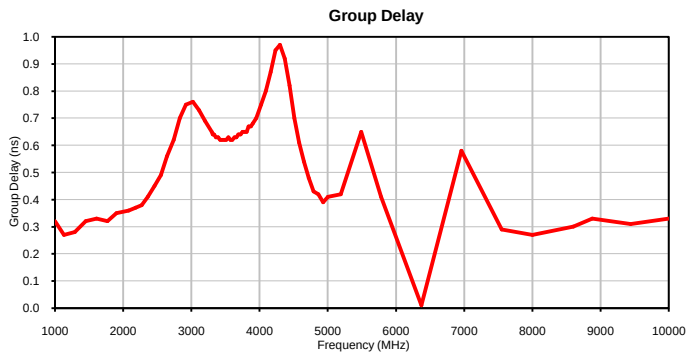
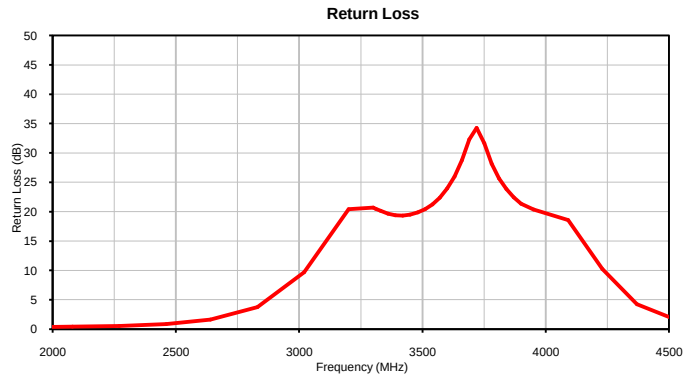
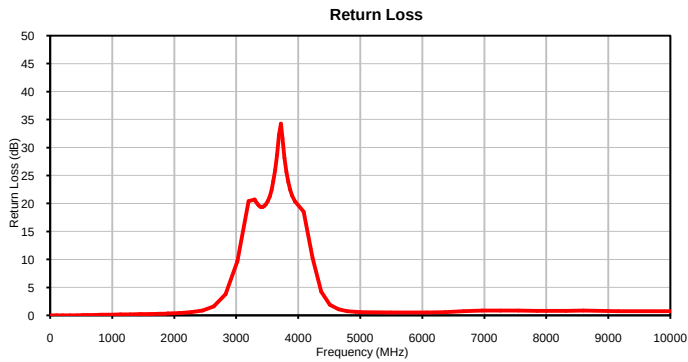
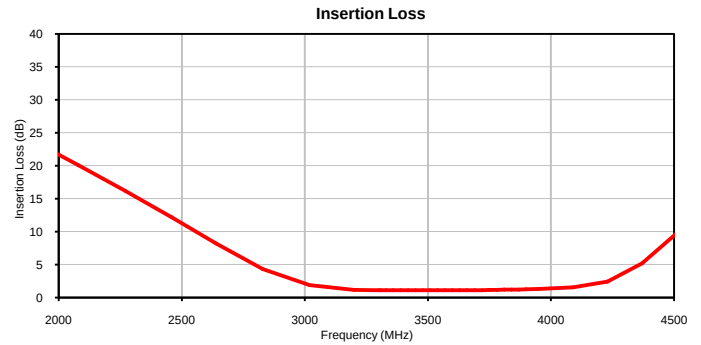
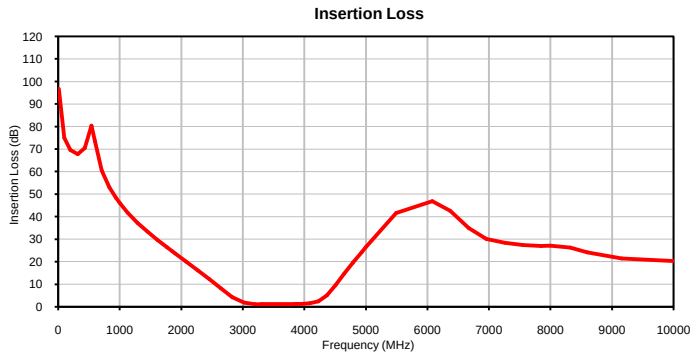
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 The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com



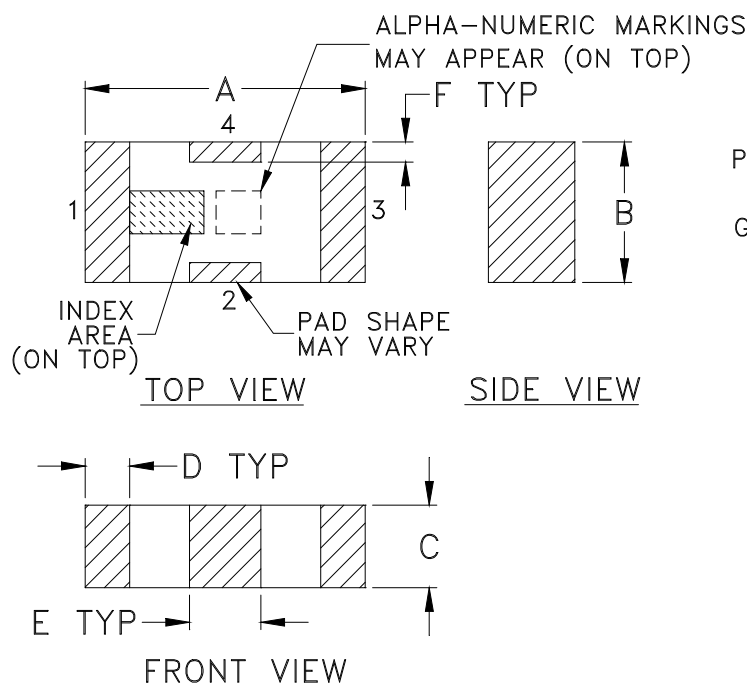
IF/RF MICROWAVE COMPONENTS

REV. OR
 BFCN-3600+
 11/21/2012
 Page 1 of 1

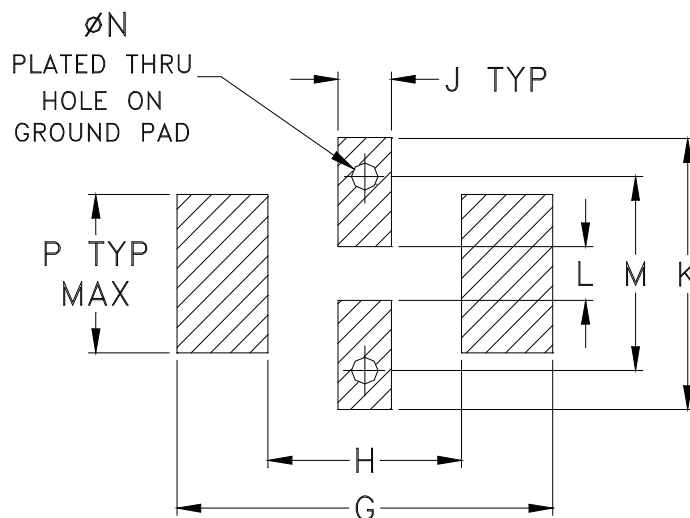
Typical Performance Curves



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N	P	WT. GRAM
FV1206	.126 (3.20)	.063 (1.60)	.037 (0.94)	.020 (0.51)	.032 (0.81)	.009 (0.23)	.169 (4.29)	.087 (2.21)	.024 (0.61)	.122 (3.10)	.024 (0.61)	.087 (2.21)	.012 (0.30)	.071 (1.80)	.020

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish: **as shown below or indicated on Data Sheet.**
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



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RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F71

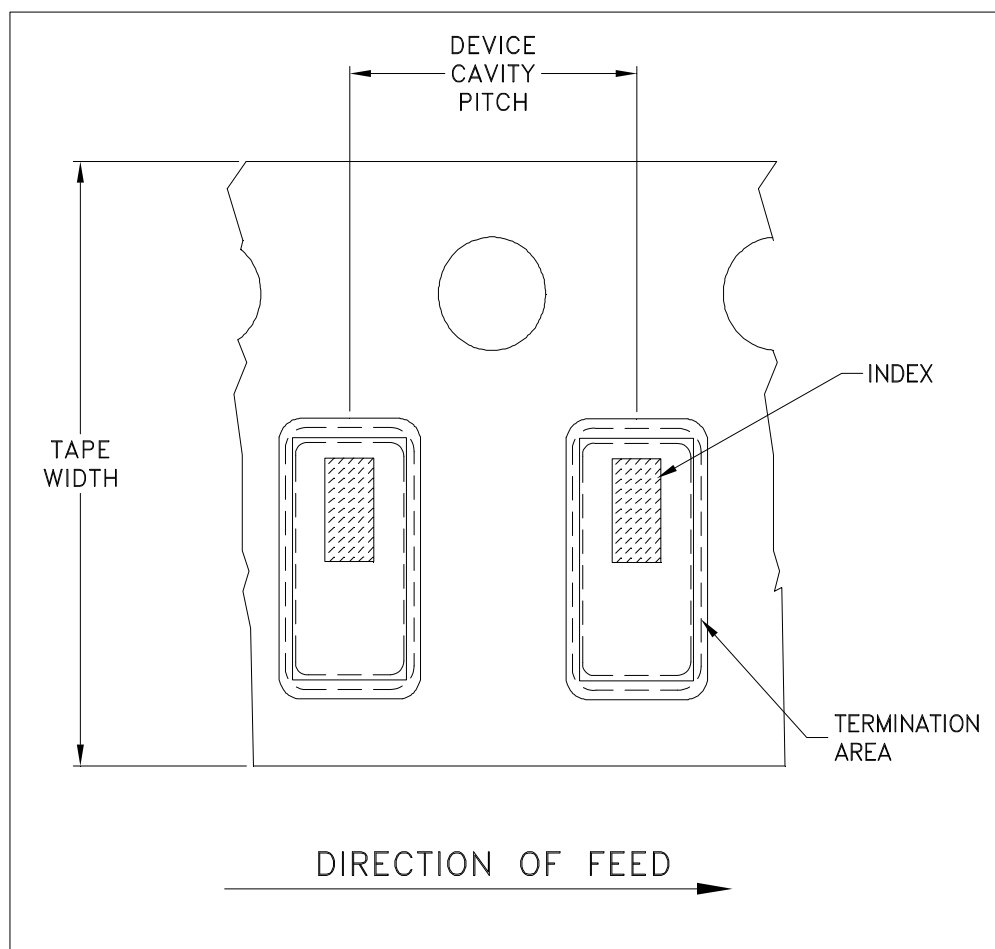


ILLUSTRATION 1

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	3000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



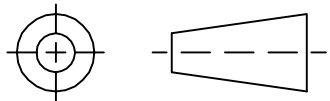
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RF/IF MICROWAVE COMPONENTS

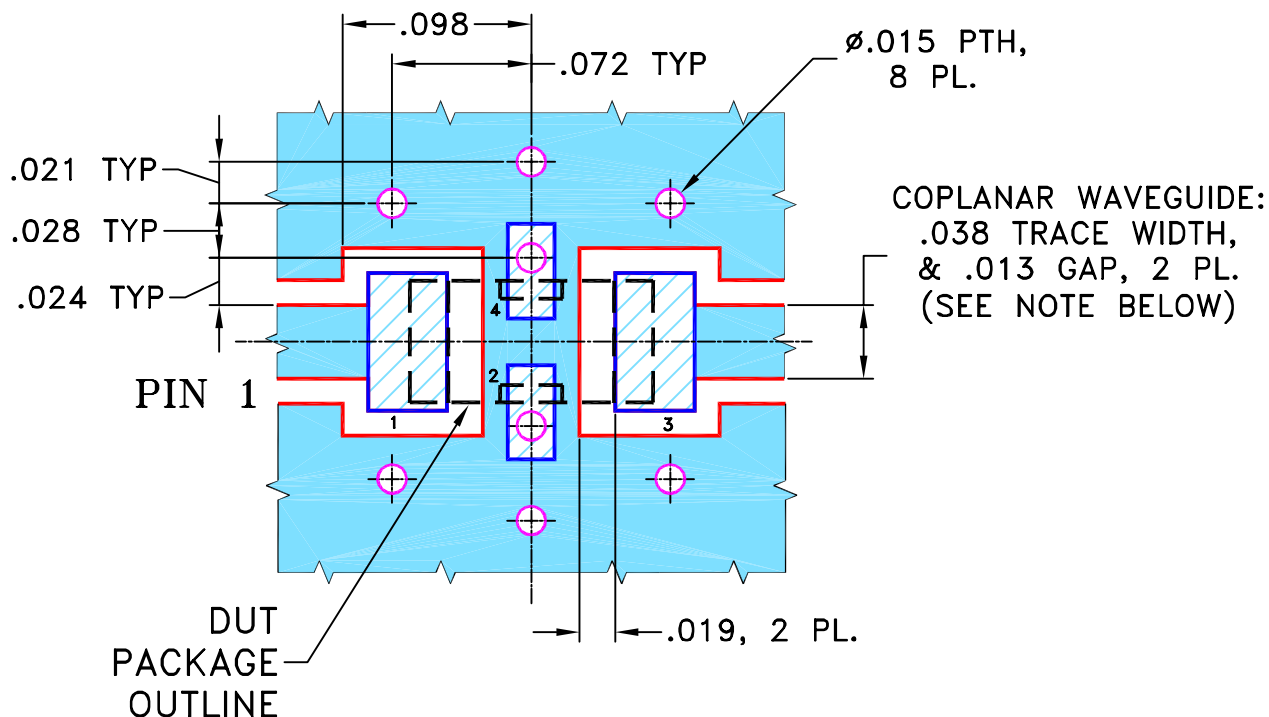
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M88634	NEW RELEASE	08/28/03	GF	ABD
A	M102713	ADDED "...WITH SMOBC"	01/17/06	MMG	IL

**SUGGESTED MOUNTING CONFIGURATION
FOR FV1206 CASE STYLE, "nx" PIN CONNECTION**

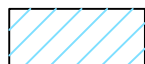


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COPPER: 1/2 OZ. EACH SIDE.
FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC
(SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS

DATE

DIMENSIONS ARE IN INCHES

TOLERANCES ON:

2 PL DECIMALS $\pm$ 3 PL DECIMALS $\pm$.005ANGLES $\pm$ FRACTIONS $\pm$

DRAWN

GF

08/27/03

CHECKED

AV

08/28/03

APPROVED

ABD

08/28/03



Mini-Circuits®

13 Neptune Avenue
Brooklyn NY 11235

PL, nx, FV1206, LFCN/HFCN, TB-270

SIZE

A

CODE IDENT

15542

DRAWING NO:

98-PL-137

REV:

A

FILE:

98PL137

SCALE:

10:1

SHEET:

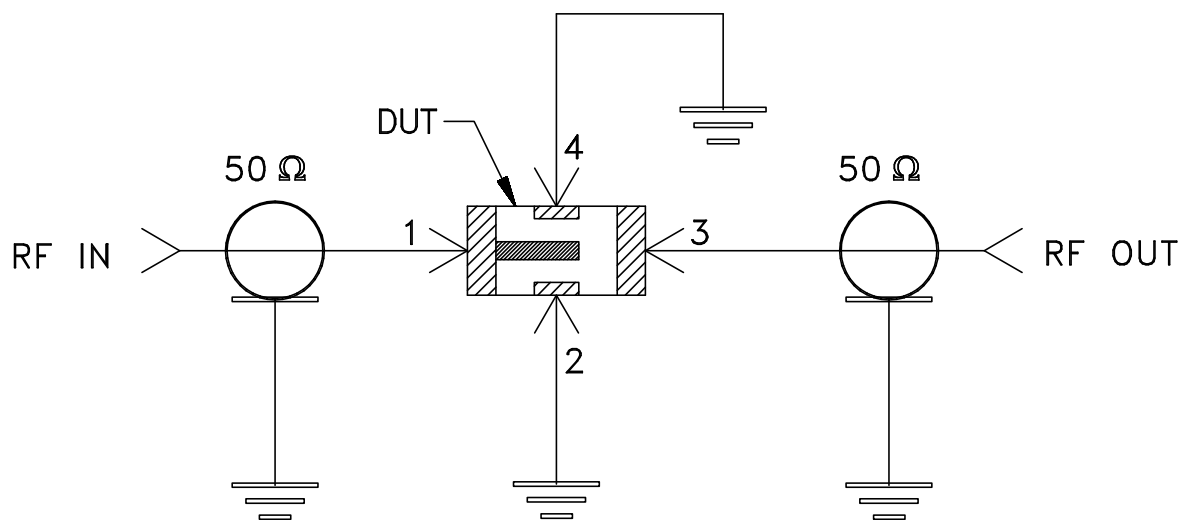
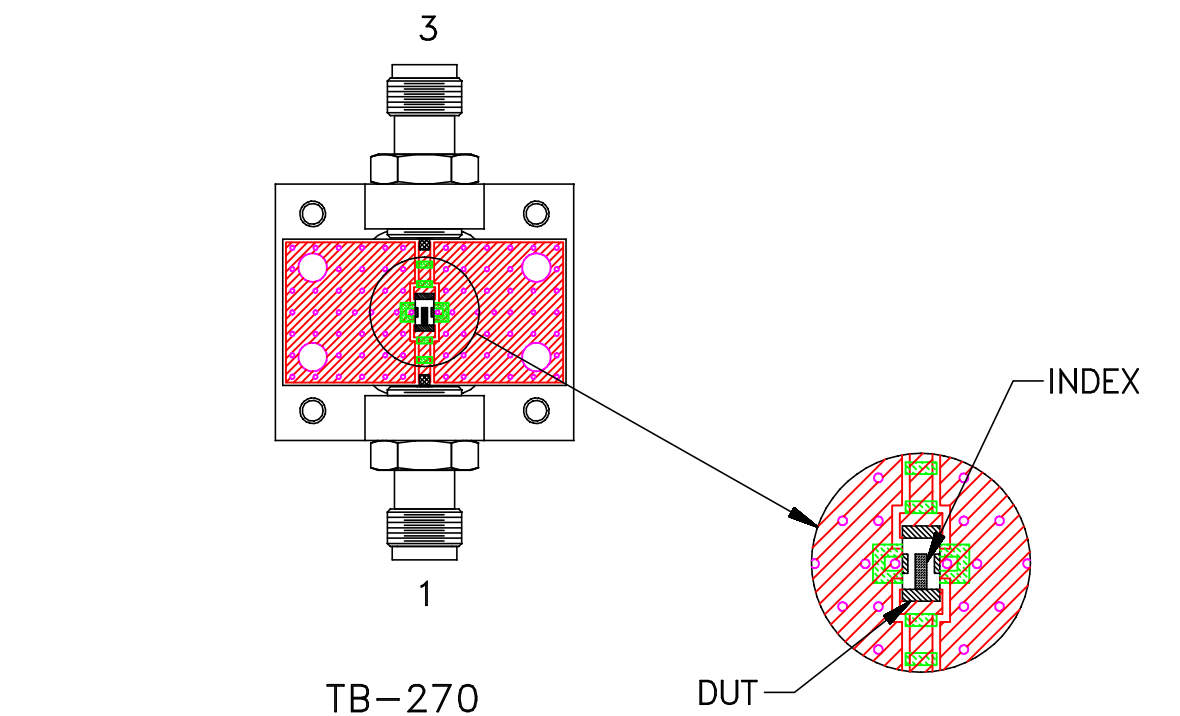
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ASHEETA1.DWG REV:A DATE:01/12/95

Evaluation Board and Circuit



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: ROGERS RO4350 or equivalent,
Dielectric Constant=3.5, Thickness=.020 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A